MEMS Probe Card용 Micro Needle 공정 연구

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Plating Process of Micro-needle for MEMS Probe Card

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Abstract: Micro probe with Ni-Co tip was designed. Unit processes for fabricating the micro probe were developed. We are investigated the micro probe tip using by Ni-Co alloy. One-step and three-step needle was fabricated by plating process, CMP, and photolithography process. The plating thickness was varied by current density and time. Futher data will be extract by different process conditions.

Key Words: MEMS Probe Card, Micro Needle, Plating